

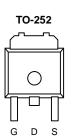
FS10AS-3-T13-VB Datasheet N-Channel 150 V (D-S) MOSFET

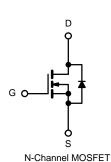
PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)		
150	0.074 at V _{GS} = 10 V	25.4	23 nC		
150	0.077 at V _{GS} = 8 V	22.5	23110		

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Extremely Low Q_{gd} for Switching Losses
- 100 % R_g Tested
- 100 % Avalanche Tested
- Compliant to RoHS Directive 2002/95/EC







APPLICATIONS

· Primary Side Switch

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	150	V	
Gate-Source Voltage		V _{GS}	± 20	v	
	T _C = 25 °C		25.4		
Continuous Drain Current (T. 150 °C)	T _C = 70 °C	1 , —	23.1		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	l _D	15.5 ^{b, c}		
	T _A = 70 °C	1	14.5 ^{b, c}	Α	
Pulsed Drain Current		I _{DM}	50		
Continuous Source-Drain Diode Current	T _C = 25 °C		4.5		
Continuous Source-Drain Diode Current	T _A = 25 °C	Is	2.6 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	20		
Single Pulse Avalanche Energy	L = 0.111111	E _{AS}	20	mJ	
	T _C = 25 °C		5.9		
Maximum Power Discinction	T _C = 70 °C		3.8	W	
Maximum Power Dissipation	T _A = 25 °C	P _D	3.1 ^{b, c}	VV	
	T _A = 70 °C	1	2 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stq}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, †}	t ≤ 10 s	R_{thJA}	33	40	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	17	21	C/ V V		

Notes

- a. Based on T_C = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under steady state conditions is 80 °C/W.



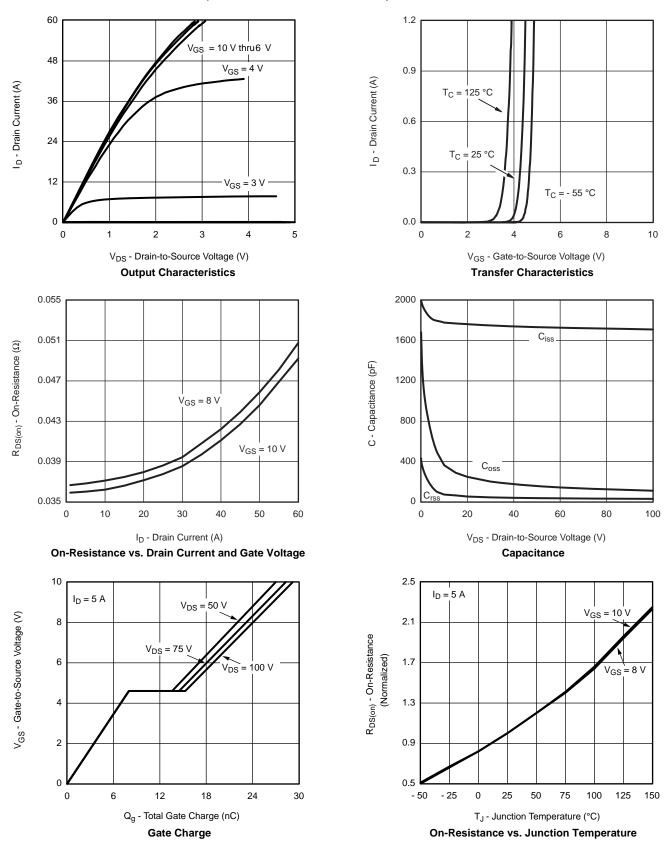
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	150			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	ν/T .		172		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 10		mv/·C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	1.5		3.0	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zara Cata Valtaga Drain Current		V _{DS} = 150 V, V _{GS} = 0 V			1	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 120 V, V _{GS} = 0 V, T _J = 55 °C	_J = 55 °C		10	μA
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α
Drain Source On State Registered	В	V _{GS} = 10 V, I _D = 5 A	0.07			0
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 8 \text{ V}, I_{D} = 5 \text{ A}$		0.077		Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 5 A		23		S
Dynamic ^b						
Input Capacitance	C _{iss}			1735		pF
Output Capacitance	C _{oss}	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		160		
Reverse Transfer Capacitance	C _{rss}			37		
Total Gate Charge	Q _g	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$		28.5	43	
Total Gate Charge				23	35	nC
Gate-Source Charge	Q_{gs}	$V_{DS} = 75 \text{ V}, V_{GS} = 8 \text{ V}, I_{D} = 5 \text{ A}$		8		
Gate-Drain Charge	Q_{gd}			6.5		
Gate Resistance	R_{g}	f = 1 MHz	0.		1.3	Ω
Turn-on Delay Time	t _{d(on)}			14	21	
Rise Time	t _r	$V_{DD} = 50 \text{ V}, R_L = 10 \Omega$		12	18	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		22	33	
Fall Time	t _f			6	10	ne
Turn-On Delay Time	t _{d(on)}			16	24	ns
Rise Time	t _r	V_{DD} = 50 V, R_L = 10 Ω		12	18	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 8 \text{ V}, R_g = 1 \Omega$		20	30	
Fall Time	t _f			7	12	
Drain-Source Body Diode Characteristi	cs					
Continuous Source-Drain Diode Current	I _S	$T_C = 25 ^{\circ}C$			7.7	Α
Pulse Diode Forward Current ^a	I _{SM}				50	
Body Diode Voltage	V _{SD}	I _S = 2.6 A		0.77	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			63	95	ns
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 5 A, dI/dt = 100 A/μs, T _{.I} = 25 °C		110	165	nC
Reverse Recovery Fall Time	t _a	$_{1F} = 3 \text{ A}$, $_{11}$ $_{100}$ $_{17}$ $_{15}$ $_{15}$ $_{15}$ $_{15}$		49		ns
Reverse Recovery Rise Time	t _b			14		

Notes:

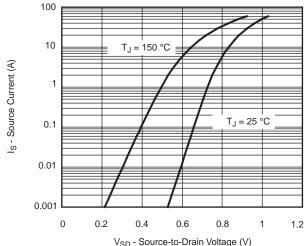
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- a. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

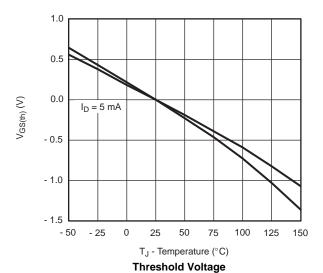




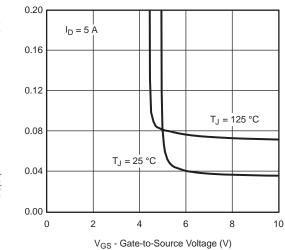




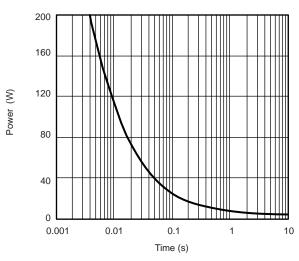
Source-Drain Diode Forward Voltage



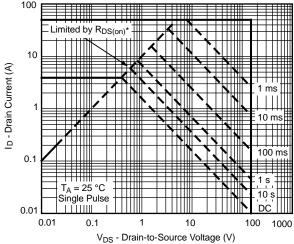
 $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$ - Drain-to-Source On-Resistance (Ω)



On-Resistance vs. Gate-to-Source Voltage



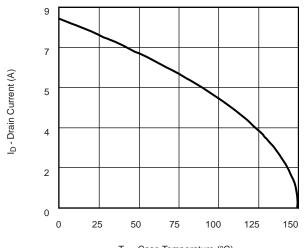
Single Pulse Power, Junction-to-Ambient



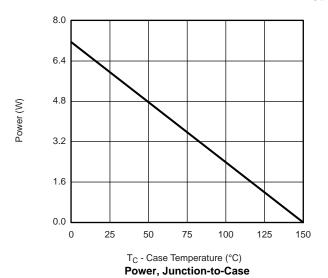
* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

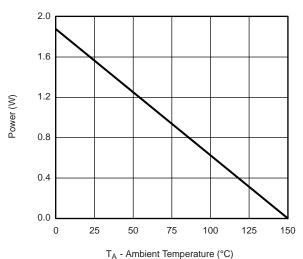
Safe Operating Area, Junction-to-Ambient





T_C - Case Temperature (°C) **Current Derating***

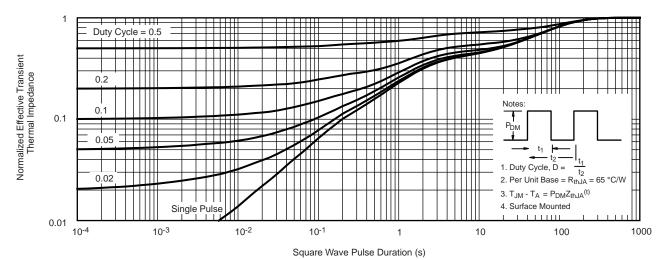




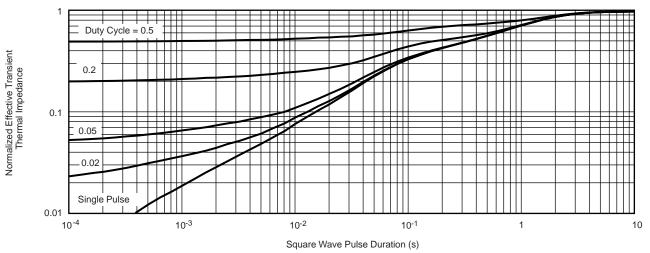
Power, Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





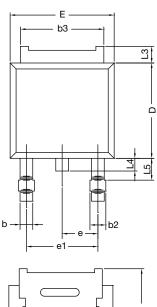
Normalized Thermal Transient Impedance, Junction-to-Ambient

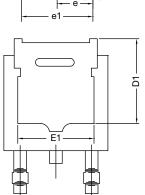


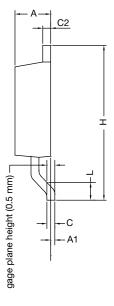
Normalized Thermal Transient Impedance, Junction-to-Foot



TO-252AA CASE OUTLINE







	MILLIN	METERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	5.21	-	0.205	-	
E	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28 BSC		0.090 BSC		
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	
ECN: X12-0247-Rev. M, 24-Dec-12					

ECN: X12-0247-Rev. M, 24-Dec-12 DWG: 5347

Note

• Dimension L3 is for reference only.

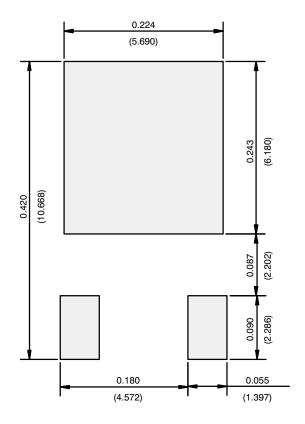
服务热线:400-655-8788

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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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